UNISONIC TECHNOLOGIES CO., LTD

MJE13007-P

Preliminary

NPN SILICON TRANSISTOR

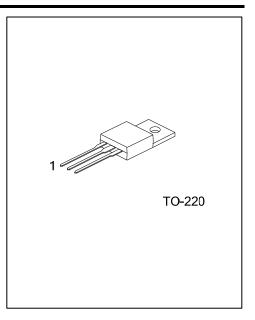
NPN BIPOLAR POWER TRANSISTOR FOR SWITCHING POWER SUPPLY APPLICATIONS

DESCRIPTION

The UTC **MJE13007-P** is designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. It is particularly suited for 115 and 220 V switch mode applications.

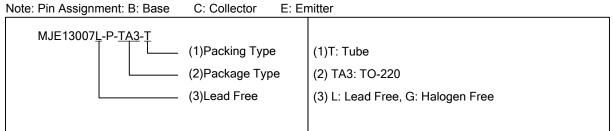
■ FEATURES

- * $V_{\text{CEO(SUS)}}400V$
- * 700V Blocking Capability



ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
MJE13007L-P-TA3-T	MJE13007G-P-TA3-T	TO-220	В	С	Е	Tube	



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■ ABSOLUTE MAXIMUM RATING

PARAMETER		SYMBOL	RATINGS	UNIT
Collector-Emitter Sustaining Voltage		$V_{\sf CEO}$	400	V
Collector-Emitter Breakdown Voltage		V_{CBO}	700	V
Emitter-Base Voltage		V_{EBO}	9.0	V
Collector Current	Continuous	Ic	8.0	Α
	Peak (1)	I _{CM}	16	Α
Barra Quarant	Continuous	Ι _Β	4.0	Α
Base Current	Peak (1)	I _{BM}	8.0	Α
F: '14 O 1	Continuous	Ι _Ε	12	Α
Emitter Current	Peak (1)	I _{EM}	24	Α
Power Dissipation (T _C = 25°C)		P_{D}	80	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T _{STG}	-55~+150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	62.5	°C/W
Junction to Case	θ_{JC}	1.56	°C/W

Note: 1. Pulse Test: Pulse Width = 5.0 ms, Duty Cycle≤10%.

Measurement made with thermocouple contacting the bottom insulated mounting surface of the package (in a location beneath the die), the device mounted on a heatsink with thermal grease applied at a mounting torque of 6 to 8•lbs.

■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Collector-Emitter Sustaining Voltage	V _{CEO(SUS)}	I_C =10mA, I_B =0	400			V
Collector Cutoff Current	I _{CBO}	V _{CES} =700V			0.1	mA
		V _{CES} =700V, T _C =125°C			1.0	mA
Emitter Cutoff Current	I _{EBO}	V_{EB} =9.0V, I_{C} =0			100	μΑ
DC Current Gain	h _{FE1}	I _C =2.0A, V _{CE} =5.0V	8.0		40	
	h _{FE2}	I _C =5.0A, V _{CE} =5.0V	5.0		30	
	V _{CE(SAT)}	I _C =2.0A, I _B =0.4A			1.0	V
Collector-Emitter Saturation Voltage		I _C =5.0A, I _B =1.0A			2.0	V
		I _C =8.0A, I _B =2.0A			3.0	V
		I _C =5.0A, I _B =1.0A, T _C =100°C			3.0	V
	V _{BE(SAT)}	I _C =2.0A, I _B =0.4A			1.2	V
Base-Emitter Saturation Voltage		I _C =5.0A, I _B =1.0A			1.6	V
		I _C =5.0A, I _B =1.0A, T _C =100°C			1.5	V
Current-Gain-Bandwidth Product	f _T	I _C =500mA, V _{CE} =10V, f=1.0 MHz	4.0	14		MHz
Output Capacitance	Сов	V_{CB} =10V, I_E =0, f=0.1MHz		80		pF
RESISTIVE LOAD (TABLE 1)						
Delay Time	t_D	\\ 405\\ I 5 0A		0.025	0.1	μs
Rise Time	t _R	V _{CC} =125V, I _C =5.0A,		0.5	1.5	μs
Storage Time	ts	l _{B1} =l _{B2} =1.0A, t _P =25μs, —Duty Cycle≤1.0%		1.8	4.0	μs
Fall Time	t _F			0.23	0.7	μs

Note: Pulse Test: Pulse Width≤300µs, Duty Cycle≤2.0%

■ TYPICAL THERMAL RESPONSE

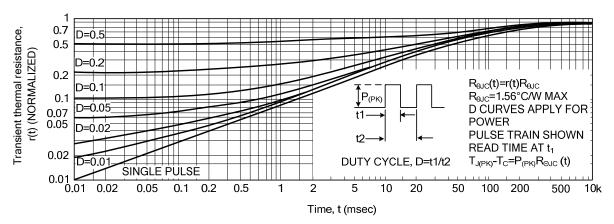


Fig. 1 Typical Thermal Response

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_{C} - V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Fig. 7 is based on $T_C = 25^{\circ}C$; $T_{J(PK)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be debated when $T_C \ge 25^{\circ}C$. Second breakdown limitations do not debate the same as thermal limitations. Allowable current at the voltages shown on Fig. 7 may be found at any case temperature by using the appropriate curve on Fig. 9.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

Use of reverse biased safe operating area data (Fig. 8) is discussed in the applications information section.

TIME

-t2

■ TYPICAL THERMAL RESPONSE(Cont.)

RESISTIVE REVERSE BIAS SAFE OPERATING AREA AND INDUCTIVE SWITCHING **SWITCHING** +125 100Ω 12P10 150Ω ±100μF 1μF CIRCUIT 3W 12P10 3W MUR8100E R_{c} R_{B1} clamp=300V/ MUR105 SCOPE EST R_{B2} 2SB824 5.1k 500Ω 150Ω D1 COMMON O 3W 12N10 500uF 51 Voff o ıμF CIRCUIT VALUES Inductive $BV_{\text{CEO}\,\text{(SUS)}}$ **RBSOA** Switching L=10mH L=500mH L=20mH $V_{CC}=125V$ R_{B2}=0 R_{B2}=8 $R_{B2} = 0$ $R_C=25\Omega$ V_{CC}=20V V_{CC}=15Volts $V_{CC}=15V$ D1=1N5820 OR EQUIV R_{B1} selected R_{B1} selected I_{C(PK)}=100mA for desired I_{B1} for desired I_{B1} TYPICAL t_F CLAMPED 25µs TE UNCLAMPED 12 t1 ADJUSTED TO **WAVEFORMS** OBTAIN IC Lcoil(I_{CM}) V_{CF} PEAK $\overline{V_{CC}}$ $Lcoil(I_{CM})$ V_{CLAMP} t1 t- V_{CE} Test Equipment Scope-Tektronix t_r, t_f<10ns 475 or Equivalent DUTY CYCLE=1.0% VCI AME RB AND RC ADJUSTED FOR DESIRED IB AND IC

Table 1. Test Conditions for Dynamic Performance

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